

BR8005 THRU BR810

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BR8005 THRU BR810

8.0A Silicon Passivated Single-Phase
Bridge Rectifiers-50-1000V

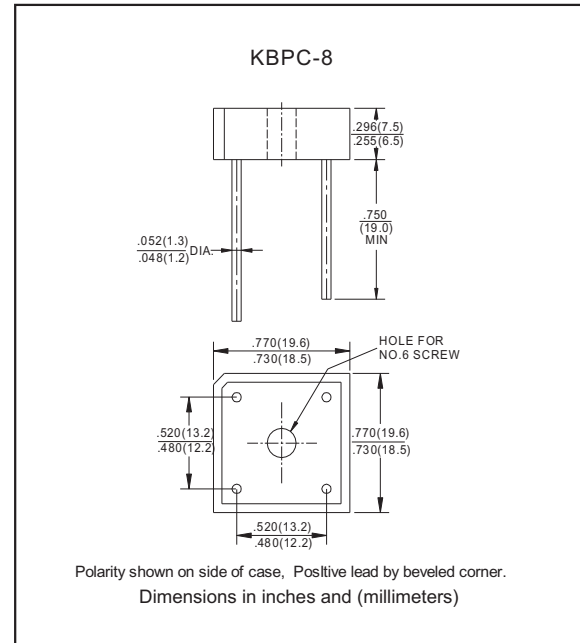
Package outline

Features

- Surge overload rating 200 amperes peak.
- Low forward voltage drop.
- Small size; simple installation.
- Silver plated copper leads.
- Lead-free parts meet RoHS requirements.
- Suffix "-H" indicates Halogen-free part, ex. BR8005-H.

Mechanical data

- Epoxy: UL94-V0 rated flame retardant
- Case : Molded plastic, KBPC-8
- Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity : marked on body
- Mounting Position : Any

Maximum ratings and Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	See Fig.1	I_O			8.0	A
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I_{FSM}			200	A
Reverse current	$V_R = V_{RRM} \quad T_J = 25^{\circ}\text{C}$	I_R			10.0	uA
	$V_R = V_{RRM} \quad T_J = 100^{\circ}\text{C}$				1000	
Storage temperature		T_{STG}	-65		+175	$^{\circ}\text{C}$

SYMBOLS	V_{RRM}^{*1} (V)	V_{RMS}^{*2} (V)	V_R^{*3} (V)	V_F^{*4} (V)	Operating temperature T_J ($^{\circ}\text{C}$)
BR8005	50	35	50	1.0	-55 to +125
BR801	100	70	100		
BR802	200	140	200		
BR804	400	280	400		
BR806	600	420	600		
BR808	800	560	800		
BR810	1000	700	1000		

*1 Repetitive peak reverse voltage

*2 RMS voltage

*3 Continuous reverse voltage

*4 Maximum forward voltage
Per Bridge Element @ $I_F=4.0\text{A}$

Rating and characteristic curves (BR8005 THRU BR810)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

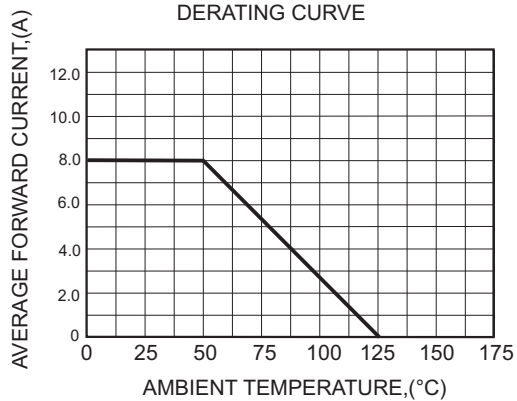


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

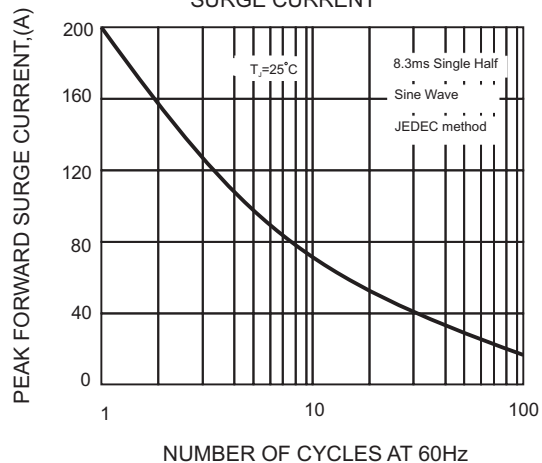


FIG.3-TYPICAL FORWARD CHARACTERISTICS

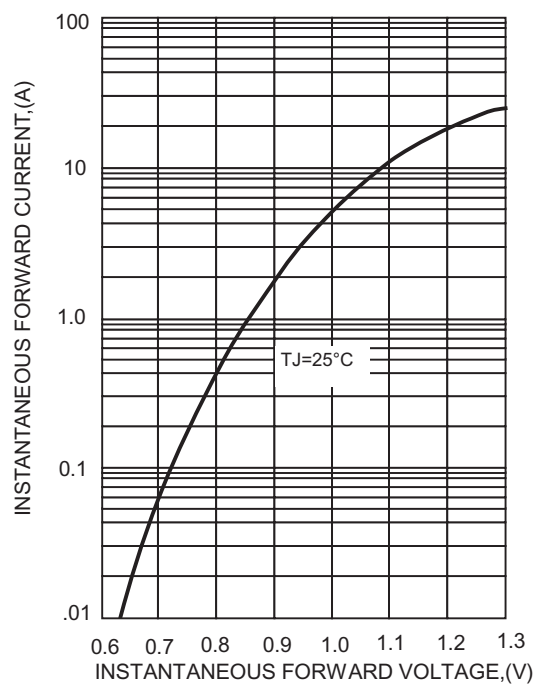
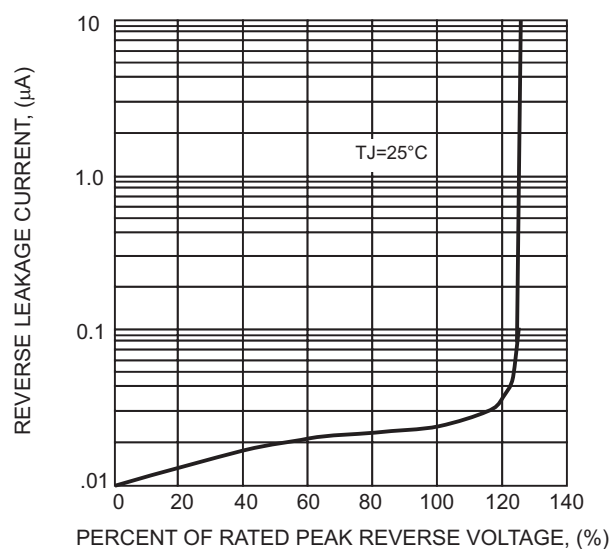
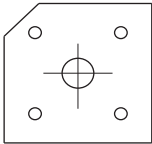
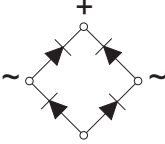


FIG.4-TYPICAL REVERSE CHARACTERISTICS



BR8005 THRU BR810**Pinning information**

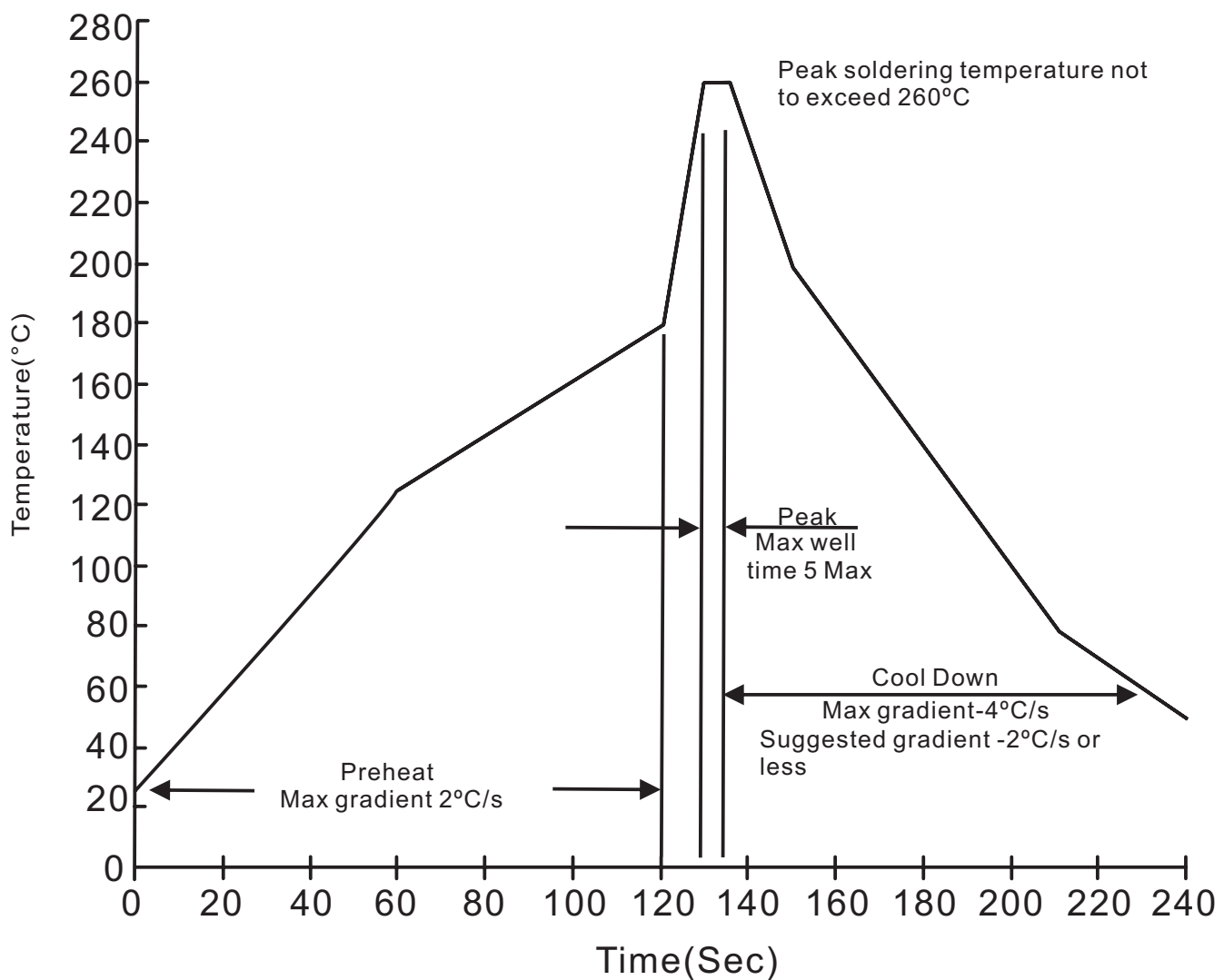
Simplified outline	Symbol
	

Marking

Type number	Marking code
BR8005	BR8005
BR801	BR801
BR802	BR802
BR804	BR804
BR806	BR806
BR808	BR808
BR810	BR810

Bulk packing

PACKAGE	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
KBPC-8	200	203*203*44	445*215*260	2,000	15.0

BR8005 THRU BR810**Suggested thermal profiles for soldering processes****1. Lead free temperature profile wave-soldering**

BR8005 THRU BR810**High reliability test capabilities**

Item Test	Conditions	Reference
1. Solder Resistance	at $260 \pm 5^{\circ}\text{C}$ for 10 ± 2 sec. immerse body into solder $1/16" \pm 1/32"$	MIL-STD-750D METHOD-2031
2. Solderability	at $245 \pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R = 80\%$ rate at $T_J = 125^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A = 25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$, $I_F = I_O$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A = 121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Thermal Shock	0°C for 5 min. rise to 100°C for 5 min. total 10 cycles.	MIL-STD-750D METHOD-1056
9. Forward Surge	8.3ms single half sine-wave superimposed on rated load, one surge.	MIL-STD-750D METHOD-4066-2
10. Humidity	at $T_A = 85^{\circ}\text{C}$, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
11. High Temperature Storage Life	at 175°C for 1000 hrs.	MIL-STD-750D METHOD-1031